









Release Date: 28 January 2016 Version: A1.0

PRODUCT DATASHEET



- ► PLCC6 SMD
- ▶ 5050 1.6t Series
- ➤ Warm White (3000K)

N0W13S81





5050 1.6t Series





FEATURES:

Package: PLCC2 White SMD Package

Forward Current: 20mA*3 Forward Voltage (typ.): 3.2V

Luminous Flux (typ.): 22lm/7000mcd@60mA

Colour: Warm White

Colour Temperature (CCT): 3000K

Viewing angle: 120°

Materials:

Die: InGaN

Resin: Silicon (Yellow Diffused)

L/T Finish: Ag plated

Operating Temperature: -40~+80°C Storage Temperature: -40~+100°C

Grouping parameters:

Forward Voltage

Luminous Intensity

CIE Chromaticity

Soldering methods: Reflow Soldering

MSL Level: MSL5 according to JEDEC

Packing: 12mm tape with 1000/reel, ø180mm (7")

APPLICATIONS:

- **General Lighting**
- Portable Lighting
- Commercial Lighting
- **Indoor Lighting**
- Backlight for LCD



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	30*3	mA
Pulse Forward Current (Duty 1/10, width 0.1ms)	I _{PF}	100*3	mA
Reverse Voltage	V_R	5	V
Reverse Current @5V	I _R	10	μΑ
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{STG}	-40~+100	°C
Junction Temperature	T _J	110	°C
Colour Rendering Index	CRI	80 (typ)	

Electrical & Optical Characteristics (Ta=25°C)

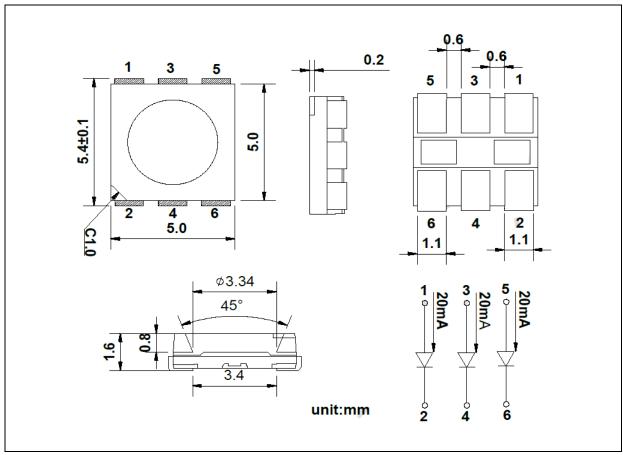
Parameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V_{F}	2.8	3.2	3.6	V	I _F =20mA*3	
Luminous Intensity	I _V	4600	7000	10100	mcd	I _F =20mA*3	
Luminous Flux	Фу		22		lm	I _F =20mA*3	
Chromaticity	Х		0.04403			I _F =20mA*3	
Coordinates	Υ		0.4043				
Colour Temperature	ССТ	2760	2960	3160	К	I _F =20mA*3	
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA*3	

^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V



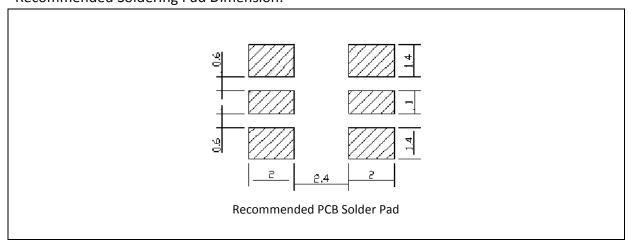
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 20mA*3$):

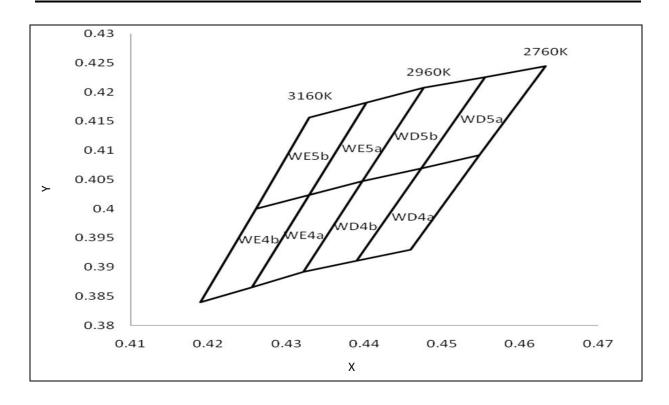
Code	Min.	Max.	Unit
В	2.8	2.9	
С	2.9	3.0	
D	3.0	3.1	
E	3.1	3.2	V
F	3.2	3.3	V
G	3.3	3.4	
Н	3.4	3.5	
I	3.5	3.6	

Luminous Intensity Classifications (I_F = 20mA*3):

Code	Min.	Max.	Unit
21	4600	6000	
22	6000	7800	lm
23	7800	10100	



CIE CHROMATICITY DIAGRAM:

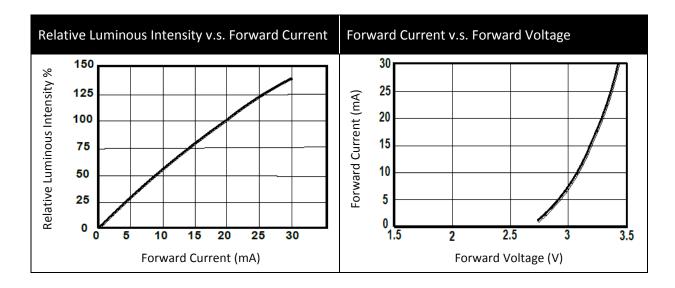


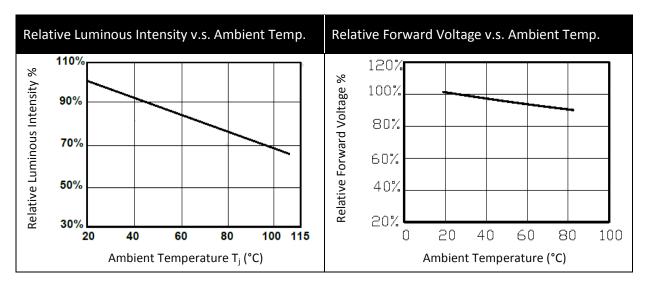
Chromaticity Coordinates Classifications (I_F = 20mA*3):

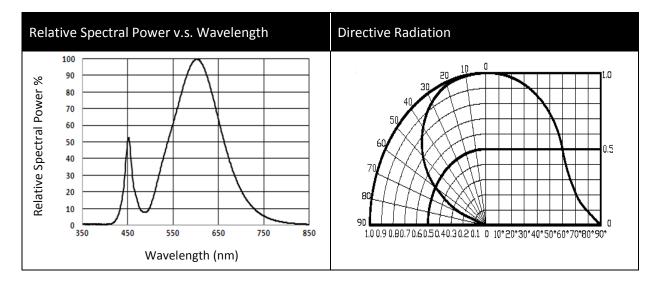
	1	l	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Υ
WE5b	0.4330	0.4157	0.4261	0.4000	0.4329	0.4024	0.4403	0.4182
WE4b	0.4261	0.4000	0.4190	0.3840	0.4256	0.3866	0.4329	0.4024
WE5a	0.4403	0.4182	0.4329	0.4024	0.4398	0.4048	0.4477	0.4208
WE4a	0.4329	0.4024	0.4256	0.3866	0.4322	0.3892	0.4398	0.4048
WD5b	0.4477	0.4208	0.4398	0.4048	0.4473	0.4070	0.4555	0.4226
WD4b	0.4398	0.4048	0.4322	0.3892	0.4391	0.3911	0.4473	0.4070
WD5a	0.4555	0.4226	0.4473	0.4070	0.4548	0.4092	0.4633	0.4245
WD4a	0.4473	0.4070	0.4391	0.3911	0.4460	0.3930	0.4548	0.4092



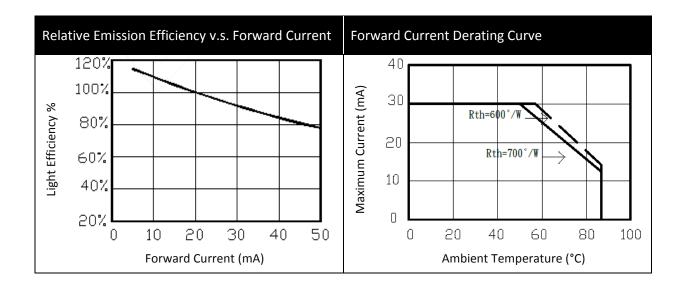
ELECTRO-OPTICAL CHARACTERISTICS:







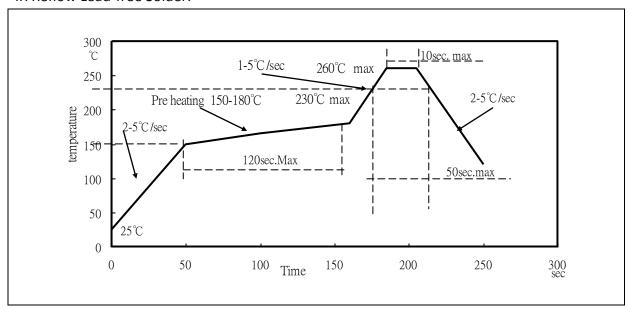






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



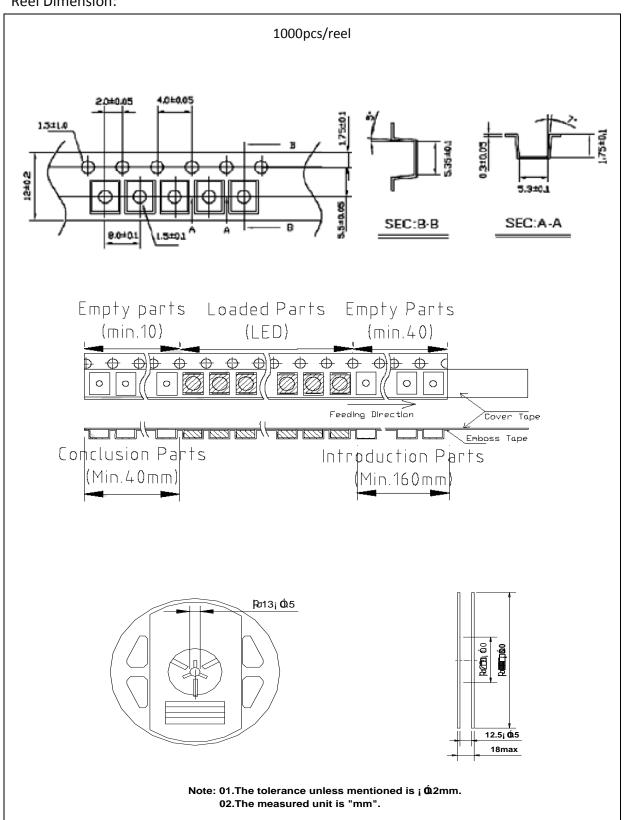
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. Recommended reflow temperature: 240°C. Maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

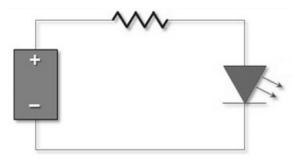
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 60±3°C x 24hrs and <5%RH, reel package.
- 125±3°C x 2hrs, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	28/01/2016	Datasheet set-up.